

EARTH LEAKAGE CURRENT DETECTOR

Automotive EARTH LEAKAGE CURRENT DETECTOR IC



BD9582F-M

General Description

BD9582F-M integrates leakage detector and amplifier. Especially, it is suitable for high sensitivity and a high-speed operation use, and since the operating temperature range is wide, it can be used for various uses.

Features

- Small temperature fluctuation and high input sensitivity
- Wide operating temperature range

Applications

- Earth leakage circuit breaker
- Earth leakage circuit relay

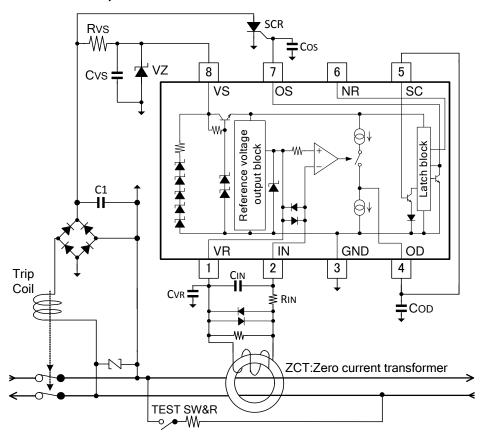
Key Specifications

■ Operating supply voltage range : 12V to 22V ■ Operating temperature range : -40° C to $+105^{\circ}$ C ■ Supply current : $330 \,\mu$ A(typ.) ■ Trip voltage : 4.48mV to 11.06mV ■ Output current ability(Ta= -40° C) : $-200 \,\mu$ A \sim (min.)

● Packages SOP8 W(Typ.) x D(Typ.) x H(Max.) 5.00mm x 6.20mm x 1.71mm

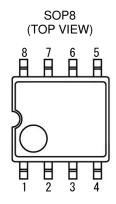


● Typical Application Circuit Example

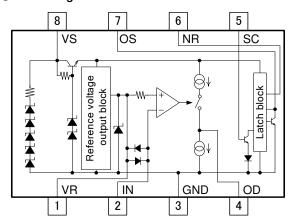


OProduct structure: Silicon monolithic integrated circuit OThis product is not designed protection against radioactive rays.

●Pin Configurations



Block Diagrams



Pin Descriptions

	2000pt.00					
Pin No.	Symbol	Function				
1	VR	Reference voltage				
2	IN	Input				
3	GND	Ground				
4	OD	Output of input comparator				
5	SC	Input of latch circuit				
6	NR	Noise absorption				
7	os	Output				
8	VS	Power supply				

■Absolute Maximum Ratings

(Ta=25°C)

(14-23-0)						
Parameter	Symbol	Rating	Unit			
Supply current *1	IS	8	mA			
IN-VR current	lin-vr	±250	mA			
VR pin current	Ivr	30	mA			
IN terminal current	lin	30	mA			
SC terminal current	Isc	5	mA			
Power Supply voltage	VS	36	V			
Input terminal voltage	Vvr/in	17	V			
OD/SC/NR/OS terminal voltage	Vod/sc/nr/os 8		V			
Power dissipation	Pd	680 ^{*2}	mW			
Storage temperature	Tstg	-55 to +150	°C			

^{*1} The power-supply voltage is limited by the internal clamping circuit.

^{*2} To use at temperature above Ta=25°C reduce 5.5mW/°C. Mounted on a glass epoxy PCB (70mm×70mm×1.6mm)

Recommended Operating Ratings

Parameter	Symbol	Limits	Unit
Supply voltage	VS	12 to 22	V
Operating temperature	Topr	-40 to +105	°C
External capacitor between VS and GND	Cvs	1≦	μF
External capacitor between OS and GND	Cos	≦1	μF

Electrical Characteristics

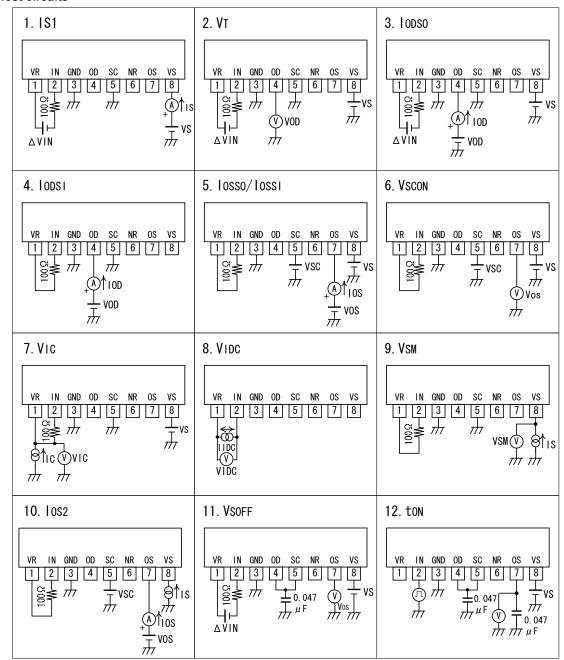
(Unless otherwise specified, VS=12V, GND=0V, Ta=25°C)

Degrapator	Symbol	Temperature range	Limits			l lmia	O a sa diki a sa a
Parameter			Min.	Тур.	Max.	Unit	Conditions
		-40°C	-	-	520		
Supply current	IS1	25°C	-	330	500	μA	ΔVIN=VvR-VIN=30mV
		105℃	-	-	460		
Trip voltage	VT	-40°C to +105°C	4.48	7.50	11.06	mV	VT=ΔVIN=VVR-VIN
OD Source current	lodso	25°C	-27.2	-20.6	-14.0	μA	ΔVIN=VvR-VIN=30mV, VoD=1.2V
OD Sink current	lodsi	25°C	16.7	26.0	35.3	μA	VOD=0.8V, ΔVIN=VVR-VIN=0mV
		-40°C	-200	-	-		
OS Source current	losso	25°C	-100	-	-	μА	Vsc=2.0V, Vos=0.8V
		105°C	-75	-	-		
OS Sink current	lossi	-40°C to +105°C	200	-	-	μA	Vsc=0.2V, Vos=0.2V
SC ON voltage	Vscon	25°C	1.00	1.24	1.48	٧	
Input clamp voltage	Vic	-40°C to +105°C	4.2	5.5	6.8	٧	IIC=20mA
Differential input clamp voltage	VIDC	-40°C to +105°C	0.5	1.0	1.5	V	IIDC=100mA
Maximum current voltage	Vsm	25°C	26	29	32	V	IS=7mA
Supply current 2 *1	los2	-40°C to +105°C	-100	-	-	μΑ	IS=900μA,Vsc=2.0V Vos=0.8V
Latch OFF Supply Voltage	Vsoff	25°C	2.7	3.7	4.7	V	
Operating time *2	ton	25°C	1.8	2.9	4.0	Ms	

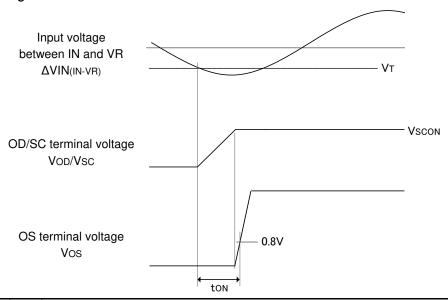
^{*1} Supply current 2 is OS source current value when the power supply current(Is=900 μ A) is given.

 $^{^{\}star}2$ Operating time is time until output voltage reaches 0.8V after detecting the leakage signal. Conditions: Capacitor(0.047 μ F) is connected between OD(OS) and GND.

Test circuits



●Timing Chart



● Typical Performance Curves (reference data)

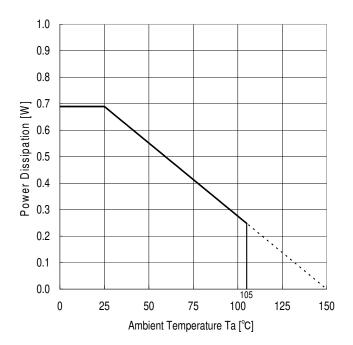


Figure 1 Derating curve

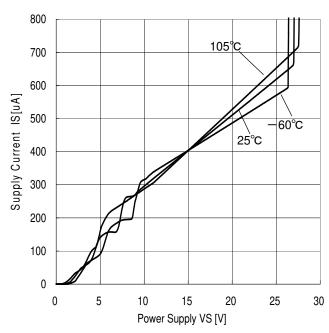


Figure 2
Circuit current - Supply voltage

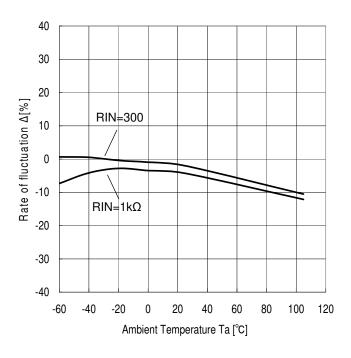


Figure 3
Trip voltage fluctuation rate
- Ambient temperature

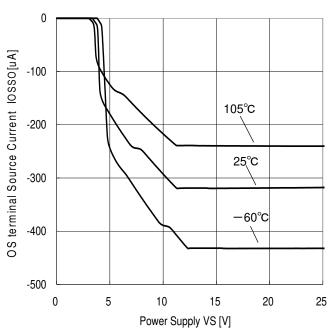


Figure 4
OS terminal source current - Supply voltage

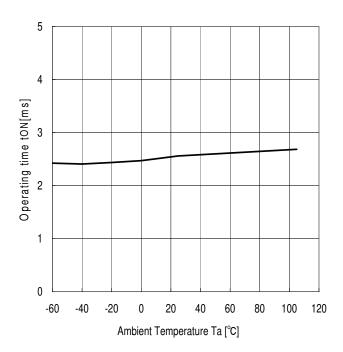


Figure 5
Operating time - Ambient temperature

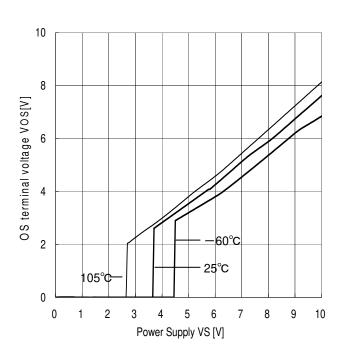


Figure 6
Latch OFF supply voltage - Ambient temperature

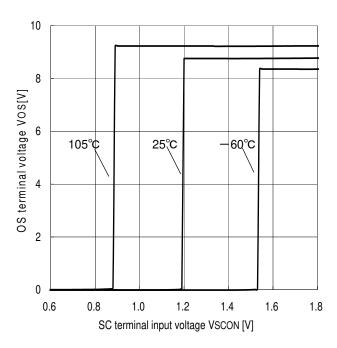


Figure 7 SC ON voltage - Ambient temperature

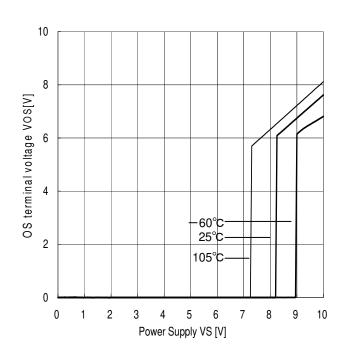


Figure 8
Latch ON supply voltage - Ambient temperature

Power Dissipation

Power dissipation(total loss) indicates the power that can be consumed by IC at Ta=25°C(normal temperature).IC is heated when it consumed power, and the temperature of IC chip becomes higher than ambient temperature. The temperature that can be accepted by IC chip depends on circuit configuration, manufacturing process, and consumable power is limited. Power dissipation is determined by the temperature allowed in IC chip (maximum junction temperature) and thermal resistance of package (heat dissipation capability). The maximum junction temperature is typically equal to the maximum value in the storage temperature range. Heat generated by consumed power of IC radiates from the mold resin or lead frame of the package. The parameter which indicates this heat dissipation capability(hardness of heat release)is called thermal resistance, represented by the symbol θ ja°C/W.The temperature of IC inside the package can be estimated by this thermal resistance. Fig.9(a) shows the model of thermal resistance of the package. Thermal resistance θ ja, ambient temperature Ta, junction temperature Tj, and power dissipation Pd can be calculated by the equation below

$$\theta ja = (Tj - Ta) / Pd$$
 °C/W · · · · · (I)

Derating curve in Fig.9(b) indicates power that can be consumed by IC with reference to ambient temperature. Power that can be consumed by IC begins to attenuate at certain ambient temperature. This gradient is determined by thermal resistance θ ja. Thermal resistance θ ja depends on chip size, power consumption, package, ambient temperature, package condition, wind velocity, etc even when the same of package is used. Thermal reduction curve indicates a reference value measured at a specified condition. Fig.10(a) show a derating curve for an example of BD9582F-M.

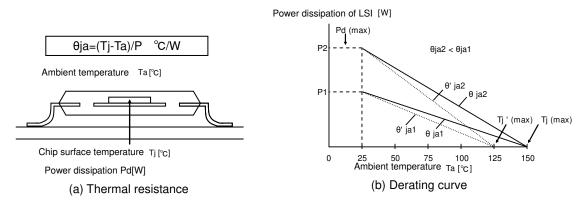
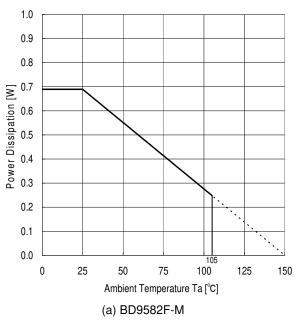


Figure 9. Thermal resistance and derating

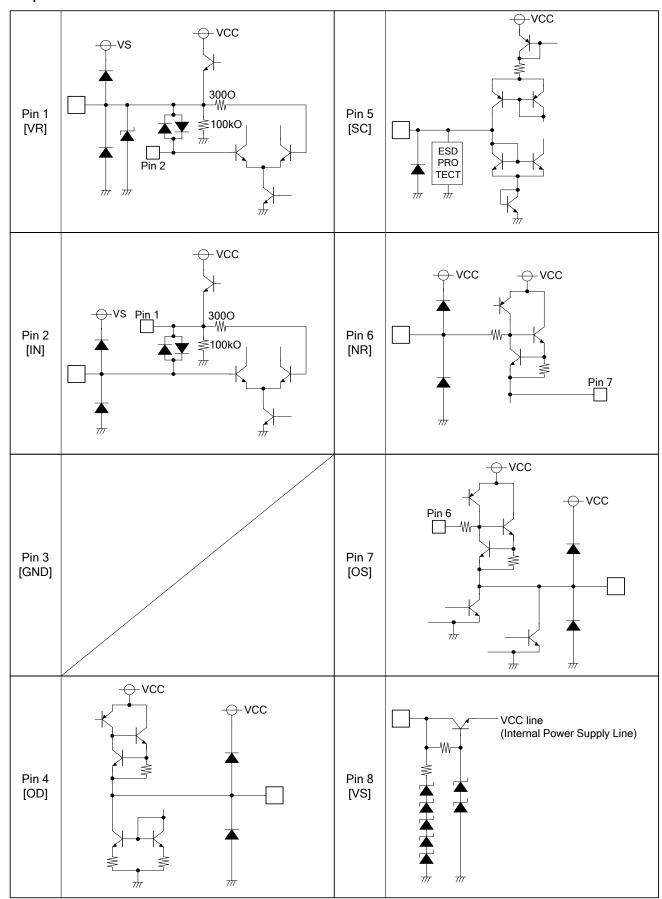


	Derating curve slope	
BD9582F-M	5.5	mW/°C

When using the unit above Ta=25°C, subtract the value above per degree°C Permissible dissipation is a value when FR4 glass epoxy board 70mm×70mm×1.6mm (cooper foil area below 3%) is mounted.

Figure 10. Derating curve

●I/O equivalence circuit



Operational Notes

1) Absolute maximum ratings

Absolute maximum ratings are the values which indicate the limits, within which the given voltage range can be safely charged to the terminal. However, it does not guarantee the circuit operation.

2) Power dissipation Pd

Using the unit in excess of the rated power dissipation may cause deterioration in electrical characteristics due to a rise in chip temperature, including reduced current capability. Therefore, please take into consideration the power dissipation (Pd) under actual operating conditions and apply a sufficient margin in thermal design. Refer to the thermal derating curves for more information.

3) Terminal short-circuits

When the output and power supply terminals are shorted, excessive output current may flow, resulting in undue heat generation and, subsequently, destruction.

4) Ground terminal voltage

All time, Ground terminal voltage should keep lowest voltage.

In addition, please confirm whether there is not really a terminal becoming the voltage that is lower than GND including a transitional phenomenon.

5) Operation in a strong electromagnetic field

Operation in a strong electromagnetic field may cause malfunctions.

6) Short-circuit between pins and erroneous mounting

Incorrect mounting may damage the IC. In addition, the presence of foreign particles between the outputs, the output and the power supply, or the output and GND may result in IC destruction.

7) IC handing

Applying mechanical stress to the IC by deflecting or bending the board may cause fluctuations in the electrical characteristics due to piezo resistance effects.

8) Board inspection

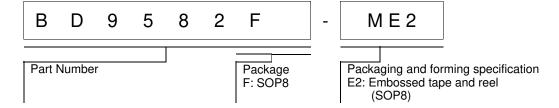
Connecting a capacitor to a pin with low impedance may stress the IC. Therefore, discharging the capacitor after every process is recommended. In addition, when attaching and detaching the jig during the inspection phase, ensure that the power is turned off before inspection and removal. Furthermore, please take measures against ESD in the assembly process as well as during transportation and storage.

Status of this document

The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.

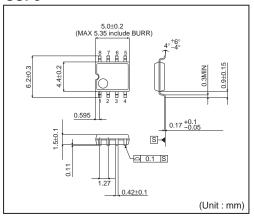
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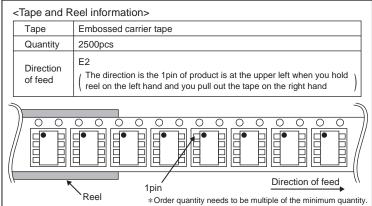
Ordering Information



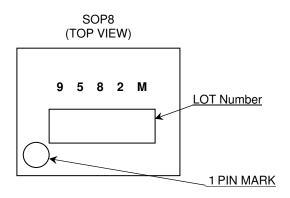
● Physical Dimension Tape and Reel Information

SOP8





Marking Diagrams



Revision History

Date	Revision	Changes
2012.10.29	001	New Release

Notice

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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLACCIII	CLASS II b	CI VCCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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